Small switching (30V, 0.1A)

Features

- 1) Two 2SK3018 transistors in a single UMT package.
- 2) Mounting cost and area can be cut in half.
- 3) Low on-resistance.
- 4) Low voltage drive (2.5V) makes this device ideal for portable equipment.
- 5) Easily designed drive circuits.

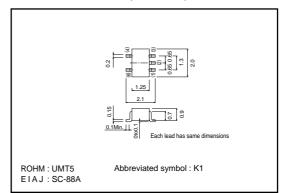
Applications

Interfacing, switching (30V, 100mA)

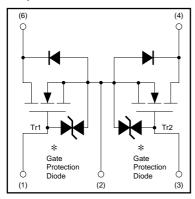
Structure

Silicon N-channel MOSFET

●External dimensions (Units : mm)



●Equivalent circuit



- (1) Tr1 Gate
- (2) Source (3) Tr2 Gate
- (4) Tr2 Drain
- (4) Tr2 Draii
- * A protection diode has been built in between the gate and the source to protect against static electricity when the product is in use. Use the protection circuit when rated voltagesare exceeded.

Packaging specifications

Туре	Package	Taping
	Code	TR
	Basic ordering unit (pieces)	3000
UM5K1N		0

● Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		VDSS	30	V
Gate-source voltage		Vgss	±20	V
Drain current	Continuous	lo	100	mA
Drain current	Pulsed	IDP*1	200	mA
Reverse drain	Continuous	IDR	100	mA
current	Pulsed	IDRP*1	200	mA
Total power dissipation (Tc=25°C)		Po*2 150		mW
Channel temperature		Tch	150	°C
Storage temperature		Tstg	−55 ~+150	°C

^{*}1 Pw≤10μs, Duty cycle≤50%

● Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Gate-source leakage	Igss	-	-	±1	μΑ	Vgs=±20V, Vps=0V
Drain-source breakdown voltage	V _{(BR)DSS}	30	_	_	V	In=10μA, Vgs=0V
Zero gate voltage drain current	IDSS	-	-	1.0	μА	V _{DS} =30V, V _{GS} =0V
Gate threshold voltage	VGS(th)	0.8	-	1.5	V	V _{DS} =3V, I _D =100μA
Static drain-source on-stage	RDS(on)	ı	5	8	Ω	In=10mA, Vgs=4V
resistance	RDS(on)	_	7	13	Ω	ID=1mA, VGS=2.5V
Forward transfer admittance	Yfs	20	_	_	mS	ID=10mA, VDS=3V
Input capacitance	Ciss	_	13	_	pF	V _{DS} =5V
Output capacitance	Coss	-	9	_	pF	Vgs=0V
Reverse transfer capacitance	Crss	-	4	_	pF	f=1MHz
Turn-on delay time	td(on)	-	15	-	ns	I _D =10mA, V _D D=5V
Rise time	tr	-	35	-	ns	Vgs=5V
Turn-off delay time	td(off)	-	80	-	ns	RL=500Ω
Fall time	tr	_	80	_	ns	R _G s=10Ω

• Electrical characteristic curves

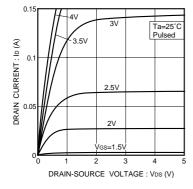


Fig.1 Typical output characteristics

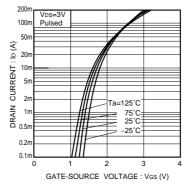


Fig.2 Typical transfer characteristics

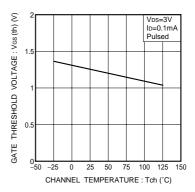
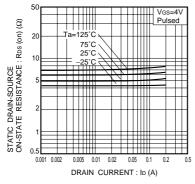
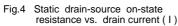


Fig.3 Gate threshold voltage vs. channel temperature



^{*2} With each pin mounted on the recommended lands.





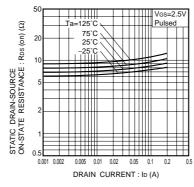


Fig.5 Static drain-source on-state resistance vs. drain current (II)

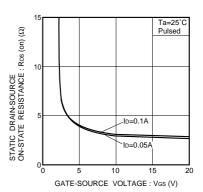


Fig.6 Static drain-source on-state resistance vs. gate-source voltage

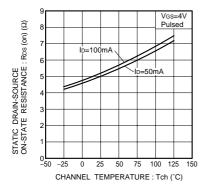


Fig.7 Static drain-source on-state resistance vs. channel temperature

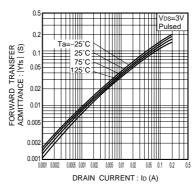


Fig.8 Forward transfer admittance vs. drain current

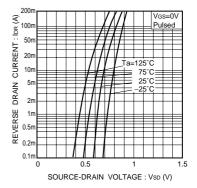


Fig.9 Reverse drain current vs. source-drain voltage (I)

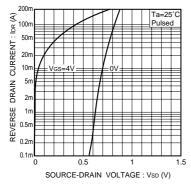


Fig.10 Reverse drain current vs. source-drain voltage (II)

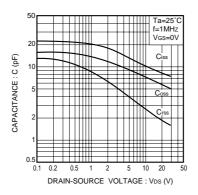


Fig.11 Typical capacitance vs. drain-source voltage

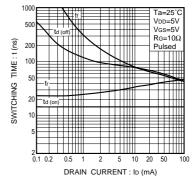


Fig.12 Switching characteristics (See Figures 13 and 14 for the measurment circuit and resultant waveforms)

•Switching characteristics measurement circuit

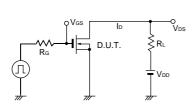


Fig.13 Switching time measurement circuit

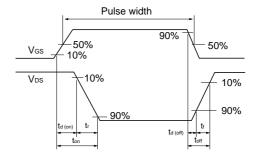


Fig.14 Switching time waveforms

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